PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kenji Wada	06/28/2010
Kazuhiro Kandatsu	06/23/2010

RECEIVING PARTY DATA

Name:	TEXAS INSTRUMENTS INCORPORATED
Street Address:	7839 CHURCHILL WAY
Internal Address:	MS 3999
City:	DALLAS
State/Country:	TEXAS
Postal Code:	75251

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12815965

CORRESPONDENCE DATA

Fax Number: (972)917-4418

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 sjolly@ti.com

Correspondent Name: TEXAS INSTRUMENTS INCORPORATED

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Address Line 2: MS 3999

Address Line 4: DALLAS, TEXAS 75251

ATTORNEY DOCKET NUMBER:	TI-67836
NAME OF SUBMITTER:	Sharon Jolly

Total Attachments: 2

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PATENT REEL: 024747 FRAME: 0861

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PATENT REEL: 024747 FRAME: 0862

ASSIGNMENT

WHEREAS, TEXAS INSTRUMENTS JAPAN, LTD. (hereinafter TLJ), a Japanese company having its headquarters at 24-1 Nishi-Shinjuku 6-chome, Shinjuku-ku, Tokyo, Japan, under the laws of Japan made application, in its own name, for Letters Patent in Japan in respect of an invention as set forth below;

WHEREAS, the or each below named inventor (hereinafter INVENTOR) is the or an inventor of the said invention;

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, having a place of business at 7839 Churchill Way, Mail Station 3999, Dallas, Texas 75251, USA, is desirous of acquiring the entire right, title and interest in and to the said invention outside of Japan, and in and to the U.S. patent application as identified hereinafter and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, by this Assignment, TIJ and INVENTOR sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns the entire right, title and interest in and to the said invention in the U.S.A. and all other countries outside Japan; in and to the U.S. patent application as identified below and all patents which may be granted therefore, and all divisions, reissues, substitutions, continuations, and extensions thereof; and the right to file applications and obtain patents in its own name in any said other country or group of countries, and to claim priority under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

TIJ and INVENTOR hereby authorize and request the Commissioner of Patents to issue U.S. patents for said invention, or U.S. patents resulting therefrom, insofar as the interest of TIJ and INVENTOR is concerned to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of the entire right, title and interest.

TIJ and INVENTOR further agree to communicate to TEXAS INSTRUMENTS INCORPORATED or to its successors, assigns and legal representatives, any facts known to TIJ and INVENTOR respecting the said invention, and at the expense of TEXAS INSTRUMENTS INCORPORATED, sign any and all patent applications, assignments, affidavits and other lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, testify in any legal or quasi-legal proceedings and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries outside of Japan.

SEMICONDUCTOR DEVICE

Title of Invention

Japanese Serial No.: 2009-150084 Filed:

06/24/2009

U.S. Application Serial No.:

12/815,965

Filed:

06/15/2010

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RECORDED: 07/27/2010

IN WITNESS WHEREOF, this Agreement has been executed as set forth below;

y Texas Instruments Japan, Ltd	
Name Kenji Wada	
ide <u>Representative Director and Pres</u> ic	lent
Date June 28, 2010	
nd by the INVENTOR;	
1) Kaznhir Kandarsu	
Cazuhiro KANDATSU	
4-1 Koizumi, Tsukuba-shi, Japan 300-4236 Address	
Agran 23 20/0	

PATENT REEL: 024747 FRAME: 0864